STP20N90K5



N-channel 900 V, 0.21 Ω typ., 20 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

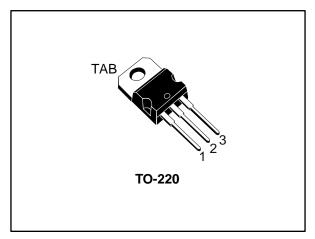
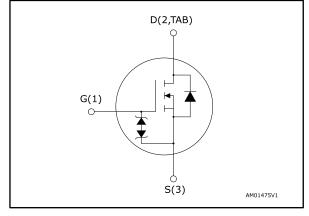


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD
STP20N90K5	900 V	0.25 Ω	20 A

- Industry's lowest R_{DS(on)} x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP20N90K5	20N90K5	TO-220	Tube

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STP20N90K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _G s	Gate-source voltage	±30	V
I _D	Drain current (continuous) at T _C = 25 °C	20	Α
ID	Drain current (continuous) at T _C = 100 °C	13	Α
I _D ⁽¹⁾	Drain current (pulsed)	80	Α
P _{TOT}	Total dissipation at T _C = 25 °C	250	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	\//n =
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	FF to 1F0	°C
T _{stg}	Storage temperature range	-55 to 150	

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	0.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	6.5	А
Eas	Single pulse avalanche energy (starting T _j = 25 °C, I _D = I _{AR} , V _{DD} = 50 V)		mJ

⁽¹⁾Pulse width limited by safe operating area

 $^{^{(2)}}I_{SD} \leq 20A, \, di/dt \leq 100 \; A/\mu s; \, V_{DS} \; peak \leq V_{(BR)DSS}, \, V_{DD} = 450 \; V$

 $^{^{(3)}}V_{DS} \le 720 \ V$

Electrical characteristics STP20N90K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	900			V
		V _{GS} = 0 V, V _{DS} = 900 V			1	μΑ
I _{DSS}	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$		0.21	0.25	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1500	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	120	-	pF
Crss	Reverse transfer capacitance	V G G — V V	-	1	-	pF
C _{o(er)} ⁽¹⁾	Equivalent capacitance time related	V _{DS} = 0 to 720 V,	-	78	-	pF
C _{o(tr)} ⁽²⁾	Equivalent capacitance energy related	V _{GS} = 0 V		220	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I _D = 0 A	-	3.7	-	Ω
Qg	Total gate charge	V _{DD} = 720 V, I _D = 20 A	-	40	-	nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	14	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior")	-	17	-	nC

Notes:

 $^{^{\}left(1\right) }$ Defined by design, not subject to production test

 $^{^{(1)}}$ Co_(er) is a constant capacitance value that gives the same stored energy as Coss while VDs is rising from 0 to 80% VDss.

 $^{^{(2)}}$ Co(tr) is a constant capacitance value that gives the same charging time as Coss while Vps is rising from 0 to 80% Vpss.

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 450 V, I _D = 10 A,	ı	20.2	-	ns
tr	Rise time	$R_G = 4.7 \Omega$	ı	13.5	-	ns
t _{d(off)}	Turn-off delay time	V _{GS} = 10 V (see Figure 13: "Test circuit	ı	64.7	-	ns
t _f	Fall time	for resistive load switching times" and Figure 18: "Switching time waveform")	-	16	-	ns

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		20	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		80	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 20 A, V _{GS} = 0 V	1		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 20 A, di/dt = 100	-	517		ns
Qrr	Reverse recovery charge	$A/\mu s, V_{DD} = 60 V$ (see Figure 15: "Test circuit	-	11.4		μC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	1	44		Α
t _{rr}	Reverse recovery time	$I_{SD} = 20 \text{ A}$, di/dt = 100 A/ μ s $V_{DD} = 60 \text{ V}$, $T_j = 150 \text{ °C}$ (see Figure 15: "Test circuit	-	674		ns
Qrr	Reverse recovery charge		-	14		μC
I _{RRM}	Reverse recovery current	for inductive load switching and diode recovery times")	-	41.6		Α

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	I_{GS} = ±1 mA, I_{D} = 0 A	30		1	V

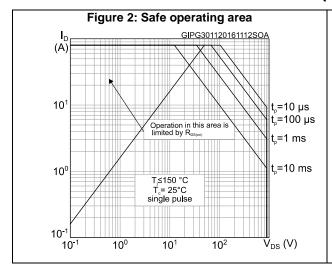
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

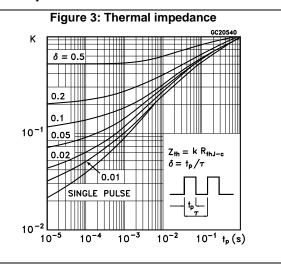


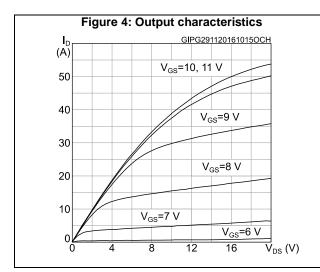
⁽¹⁾Pulse width limited by safe operating area

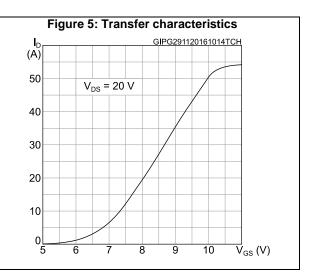
⁽²⁾Pulsed: pulse duration = 300 μs, duty cycle 1.5%

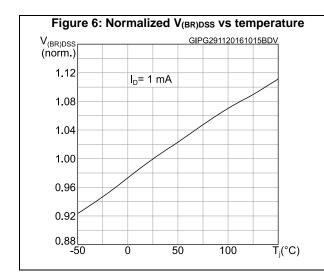
2.1 Electrical characteristics (curves)

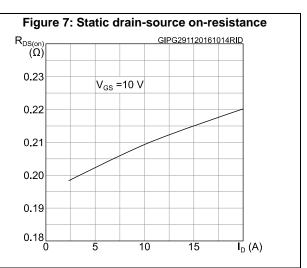






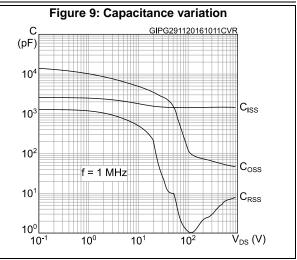


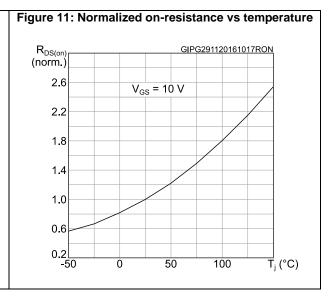


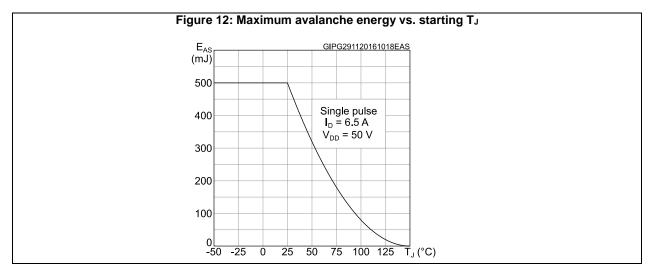


STP20N90K5 Electrical characteristics

Figure 8: Gate charge vs gate-source voltage GIPG291120161013QVG V_{DS} (V) V_{DS} V_{DD}= 720 V I_D= 20 A $\overrightarrow{Q}_g(nC)$

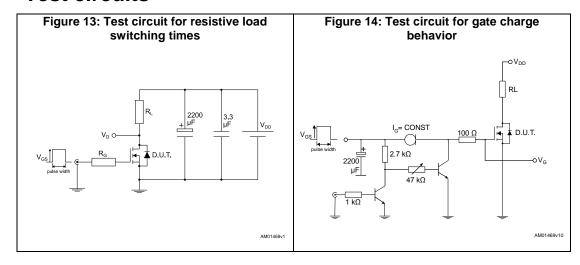


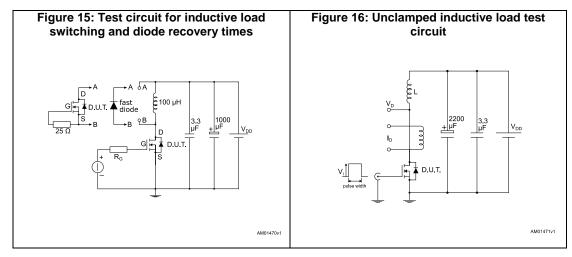


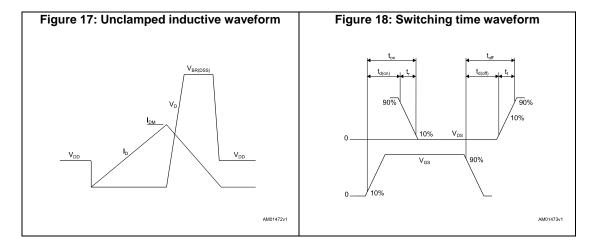


Test circuits STP20N90K5

3 Test circuits







STP20N90K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220 type A package information

Figure 19: TO-220 type A package outline

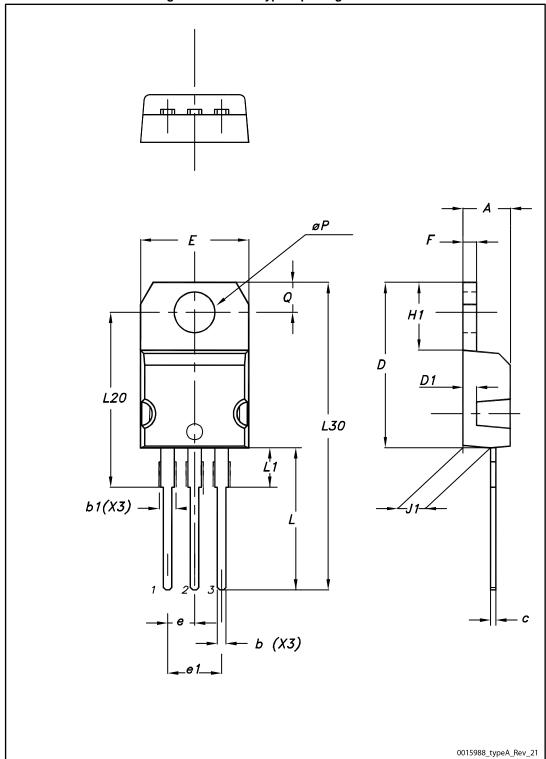


Table 10: TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

Revision history STP20N90K5

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
10-May-2016	1	First release.
01-Dec-2016	2	Modified: title and R _{DS(on)} value in cover page Modified Table 4: "Avalanche characteristics", Table 5: "On/off-state", Table 6: "Dynamic", Table 7: "Switching times" and Table 8: "Sourcedrain diode" Added Section 2.1: "Electrical characteristics (curves)" Modified Section 3: "Test circuits" Datasheet promoted from preliminary data to production data Minor text changes
24-Jan-2017	3	Modified <i>Table 6: "Dynamic"</i> . Minor text changes.

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